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## Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

## Applications of Embedded - CPLDs

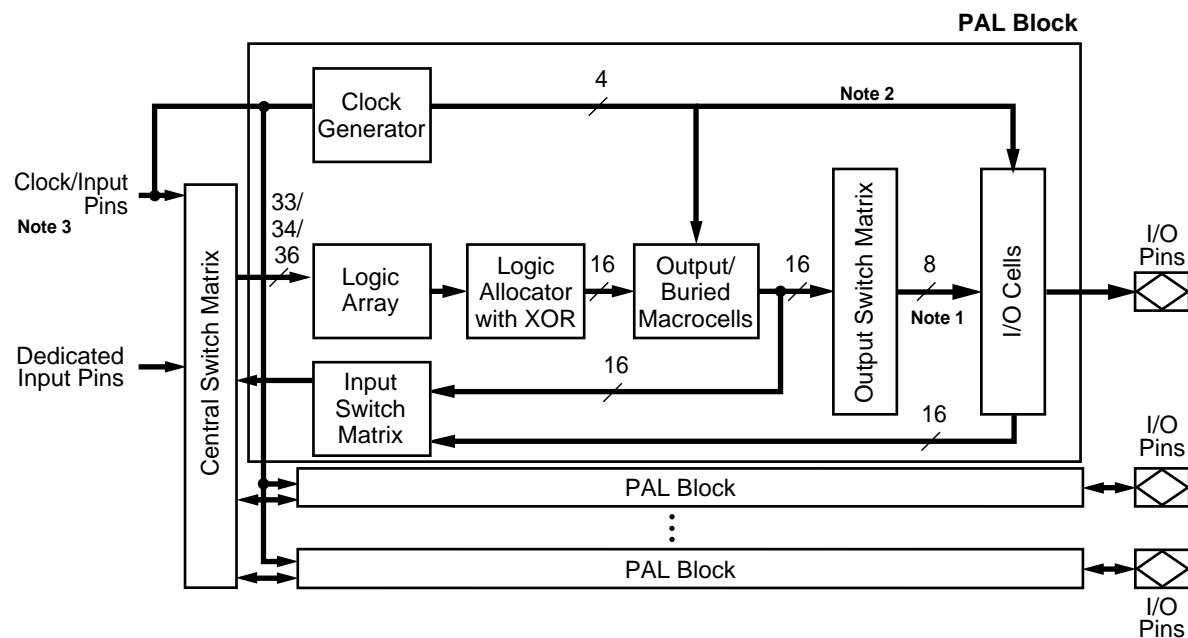
### Details

Product Status	Not For New Designs
Programmable Type	In System Programmable
Delay Time tpd(1) Max	10 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	-
Number of Macrocells	256
Number of Gates	-
Number of I/O	128
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/lattice-semiconductor/m4a3-256-128-10yni">https://www.e-xfl.com/product-detail/lattice-semiconductor/m4a3-256-128-10yni</a>

## FUNCTIONAL DESCRIPTION

The fundamental architecture of ispMACH 4A devices (Figure 1) consists of multiple, optimized PAL® blocks interconnected by a central switch matrix. The central switch matrix allows communication between PAL blocks and routes inputs to the PAL blocks. Together, the PAL blocks and central switch matrix allow the logic designer to create large designs in a single device instead of having to use multiple devices.

The key to being able to make effective use of these devices lies in the interconnect schemes. In the ispMACH 4A architecture, the macrocells are flexibly coupled to the product terms through the logic allocator, and the I/O pins are flexibly coupled to the macrocells due to the output switch matrix. In addition, more input routing options are provided by the input switch matrix. These resources provide the flexibility needed to fit designs efficiently.



17466G-001

**Figure 1. ispMACH 4A Block Diagram and PAL Block Structure**

### Notes:

1. 16 for ispMACH 4A devices with 1:1 macrocell-I/O cell ratio (see next page).
2. Block clocks do not go to I/O cells in M4A(3,5)-32/32.
3. M4A(3,5)-192, M4A(3,5)-256, M4A3-384, and M4A3-512 have dedicated clock pins which cannot be used as inputs and do not connect to the central switch matrix.

## Product-Term Array

The product-term array consists of a number of product terms that form the basis of the logic being implemented. The inputs to the AND gates come from the central switch matrix (Table 5), and are provided in both true and complement forms for efficient logic implementation.

**Table 5. PAL Block Inputs**

Device	Number of Inputs to PAL Block
M4A3-32/32 and M4A5-32/32	33
M4A3-64/32 and M4A5-64/32	33
M4A3-64/64	33
M4A3-96/48 and M4A5-96/48	33
M4A3-128/64 and M4A5-128/64	33
M4A3-192/96 and M4A5-192/96	34
M4A3-256/128 and M4A5-256/128	34
M4A3-256/160 and M4A3-256/192	36
M4A3-384	36
M4A3-512	36

## Logic Allocator

Within the logic allocator, product terms are allocated to macrocells in “product term clusters.” The availability and distribution of product term clusters are automatically considered by the software as it fits functions within a PAL block. The size of a product term cluster has been optimized to provide high utilization of product terms, making complex functions using many product terms possible. Yet when few product terms are used, there will be a minimal number of unused—or wasted—product terms left over. The product term clusters available to each macrocell within a PAL block are shown in Tables 6 and 7.

Each product term cluster is associated with a macrocell. The size of a cluster depends on the configuration of the associated macrocell. When the macrocell is used in synchronous mode (Figure 2a), the basic cluster has 4 product terms. When the associated macrocell is used in asynchronous mode (Figure 2b), the cluster has 2 product terms. Note that if the product term cluster is routed to a different macrocell, the allocator configuration is not determined by the mode of the macrocell actually being driven. The configuration is always set by the mode of the macrocell that the cluster will drive if not routed away, regardless of the actual routing.

In addition, there is an extra product term that can either join the basic cluster to give an extended cluster, or drive the second input of an exclusive-OR gate in the signal path. If included with the basic cluster, this provides for up to 20 product terms on a synchronous function that uses four extended 5-product-term clusters. A similar asynchronous function can have up to 18 product terms.

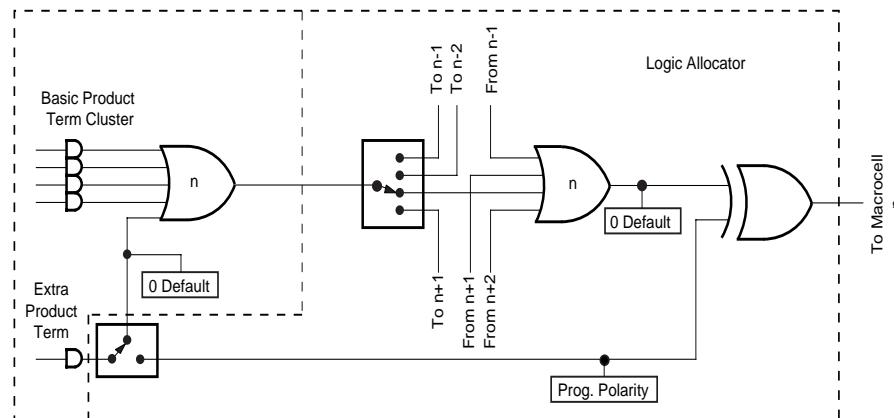
When the extra product term is used to extend the cluster, the value of the second XOR input can be programmed as a 0 or a 1, giving polarity control. The possible configurations of the logic allocator are shown in Figures 3 and 4.

**Table 6. Logic Allocator for All ispMACH 4A Devices (except M4A(3,5)-32/32)**

Output Macrocell	Available Clusters	Output Macrocell	Available Clusters
M <sub>0</sub>	C <sub>0</sub> , C <sub>1</sub> , C <sub>2</sub>	M <sub>8</sub>	C <sub>7</sub> , C <sub>8</sub> , C <sub>9</sub> , C <sub>10</sub>
M <sub>1</sub>	C <sub>0</sub> , C <sub>1</sub> , C <sub>2</sub> , C <sub>3</sub>	M <sub>9</sub>	C <sub>8</sub> , C <sub>9</sub> , C <sub>10</sub> , C <sub>11</sub>
M <sub>2</sub>	C <sub>1</sub> , C <sub>2</sub> , C <sub>3</sub> , C <sub>4</sub>	M <sub>10</sub>	C <sub>9</sub> , C <sub>10</sub> , C <sub>11</sub> , C <sub>12</sub>
M <sub>3</sub>	C <sub>2</sub> , C <sub>3</sub> , C <sub>4</sub> , C <sub>5</sub>	M <sub>11</sub>	C <sub>10</sub> , C <sub>11</sub> , C <sub>12</sub> , C <sub>13</sub>
M <sub>4</sub>	C <sub>3</sub> , C <sub>4</sub> , C <sub>5</sub> , C <sub>6</sub>	M <sub>12</sub>	C <sub>11</sub> , C <sub>12</sub> , C <sub>13</sub> , C <sub>14</sub>
M <sub>5</sub>	C <sub>4</sub> , C <sub>5</sub> , C <sub>6</sub> , C <sub>7</sub>	M <sub>13</sub>	C <sub>12</sub> , C <sub>13</sub> , C <sub>14</sub> , C <sub>15</sub>
M <sub>6</sub>	C <sub>5</sub> , C <sub>6</sub> , C <sub>7</sub> , C <sub>8</sub>	M <sub>14</sub>	C <sub>13</sub> , C <sub>14</sub> , C <sub>15</sub>
M <sub>7</sub>	C <sub>6</sub> , C <sub>7</sub> , C <sub>8</sub> , C <sub>9</sub>	M <sub>15</sub>	C <sub>14</sub> , C <sub>15</sub>

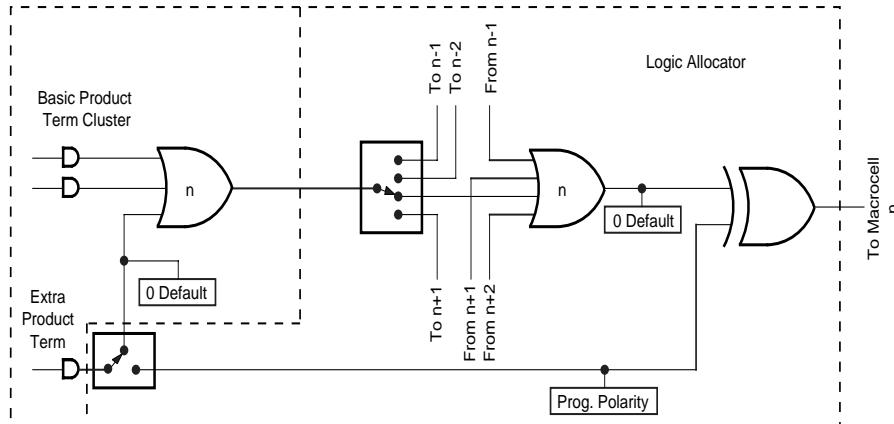
**Table 7. Logic Allocator for M4A(3,5)-32/32**

Output Macrocell	Available Clusters	Output Macrocell	Available Clusters
M <sub>0</sub>	C <sub>0</sub> , C <sub>1</sub> , C <sub>2</sub>	M <sub>8</sub>	C <sub>8</sub> , C <sub>9</sub> , C <sub>10</sub>
M <sub>1</sub>	C <sub>0</sub> , C <sub>1</sub> , C <sub>2</sub> , C <sub>3</sub>	M <sub>9</sub>	C <sub>8</sub> , C <sub>9</sub> , C <sub>10</sub> , C <sub>11</sub>
M <sub>2</sub>	C <sub>1</sub> , C <sub>2</sub> , C <sub>3</sub> , C <sub>4</sub>	M <sub>10</sub>	C <sub>9</sub> , C <sub>10</sub> , C <sub>11</sub> , C <sub>12</sub>
M <sub>3</sub>	C <sub>2</sub> , C <sub>3</sub> , C <sub>4</sub> , C <sub>5</sub>	M <sub>11</sub>	C <sub>10</sub> , C <sub>11</sub> , C <sub>12</sub> , C <sub>13</sub>
M <sub>4</sub>	C <sub>3</sub> , C <sub>4</sub> , C <sub>5</sub> , C <sub>6</sub>	M <sub>12</sub>	C <sub>11</sub> , C <sub>12</sub> , C <sub>13</sub> , C <sub>14</sub>
M <sub>5</sub>	C <sub>4</sub> , C <sub>5</sub> , C <sub>6</sub> , C <sub>7</sub>	M <sub>13</sub>	C <sub>12</sub> , C <sub>13</sub> , C <sub>14</sub> , C <sub>15</sub>
M <sub>6</sub>	C <sub>5</sub> , C <sub>6</sub> , C <sub>7</sub>	M <sub>14</sub>	C <sub>13</sub> , C <sub>14</sub> , C <sub>15</sub>
M <sub>7</sub>	C <sub>6</sub> , C <sub>7</sub>	M <sub>15</sub>	C <sub>14</sub> , C <sub>15</sub>



a. Synchronous Mode

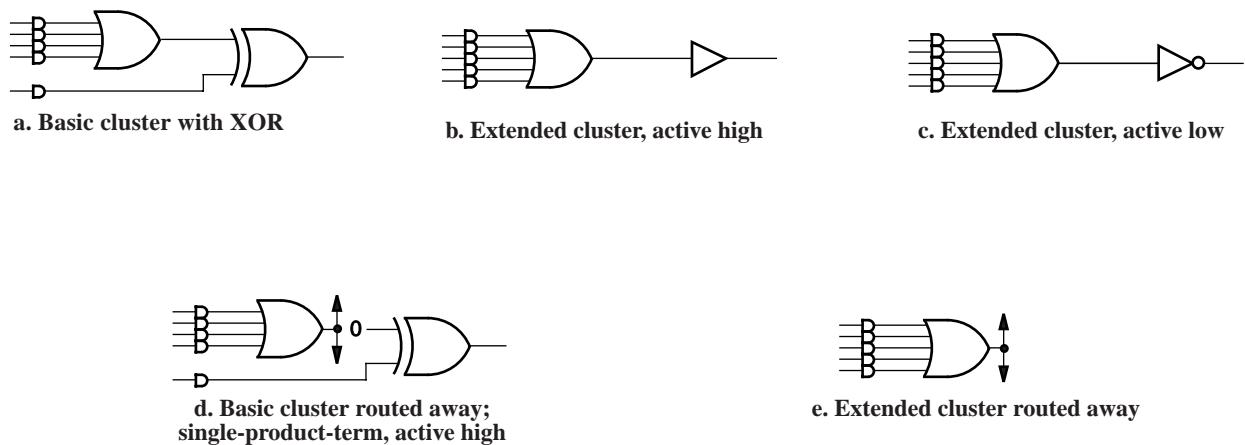
17466G-005



b. Asynchronous Mode

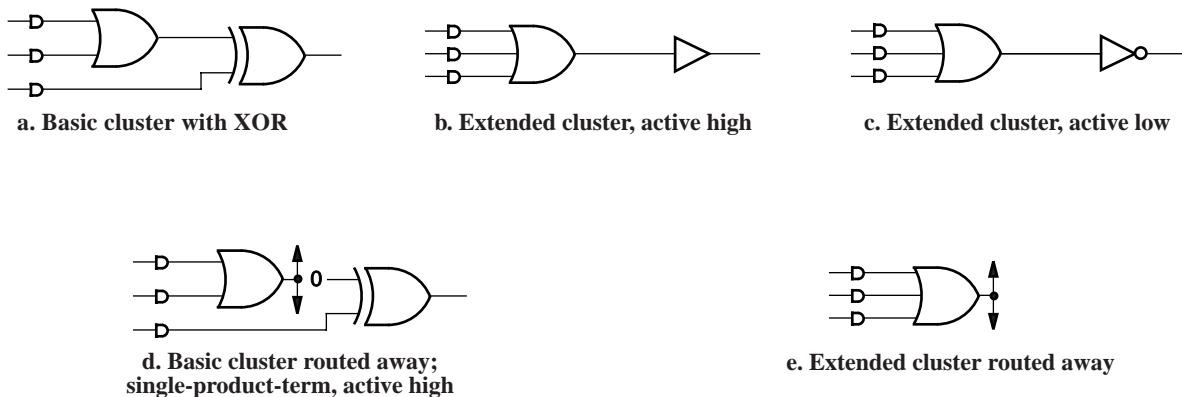
17466G-006

**Figure 2. Logic Allocator: Configuration of Cluster "n" Set by Mode of Macrocell "n"**



17466G-007

**Figure 3. Logic Allocator Configurations: Synchronous Mode**



17466G-008

**Figure 4. Logic Allocator Configurations: Asynchronous Mode**

Note that the configuration of the logic allocator has absolutely no impact on the speed of the signal. All configurations have the same delay. This means that designers do not have to decide between optimizing resources or speed; both can be optimized.

If not used in the cluster, the extra product term can act in conjunction with the basic cluster to provide XOR logic for such functions as data comparison, or it can work with the D-, T-type flip-flop to provide for J-K, and S-R register operation. In addition, if the basic cluster is routed to another macrocell, the extra product term is still available for logic. In this case, the first XOR input will be a logic 0. This circuit has the flexibility to route product terms elsewhere without giving up the use of the macrocell.

Product term clusters do not “wrap” around a PAL block. This means that the macrocells at the ends of the block have fewer product terms available.

## Macrocell

The macrocell consists of a storage element, routing resources, a clock multiplexer, and initialization control. The macrocell has two fundamental modes: synchronous and asynchronous (Figure 5). The mode chosen only affects clocking and initialization in the macrocell.

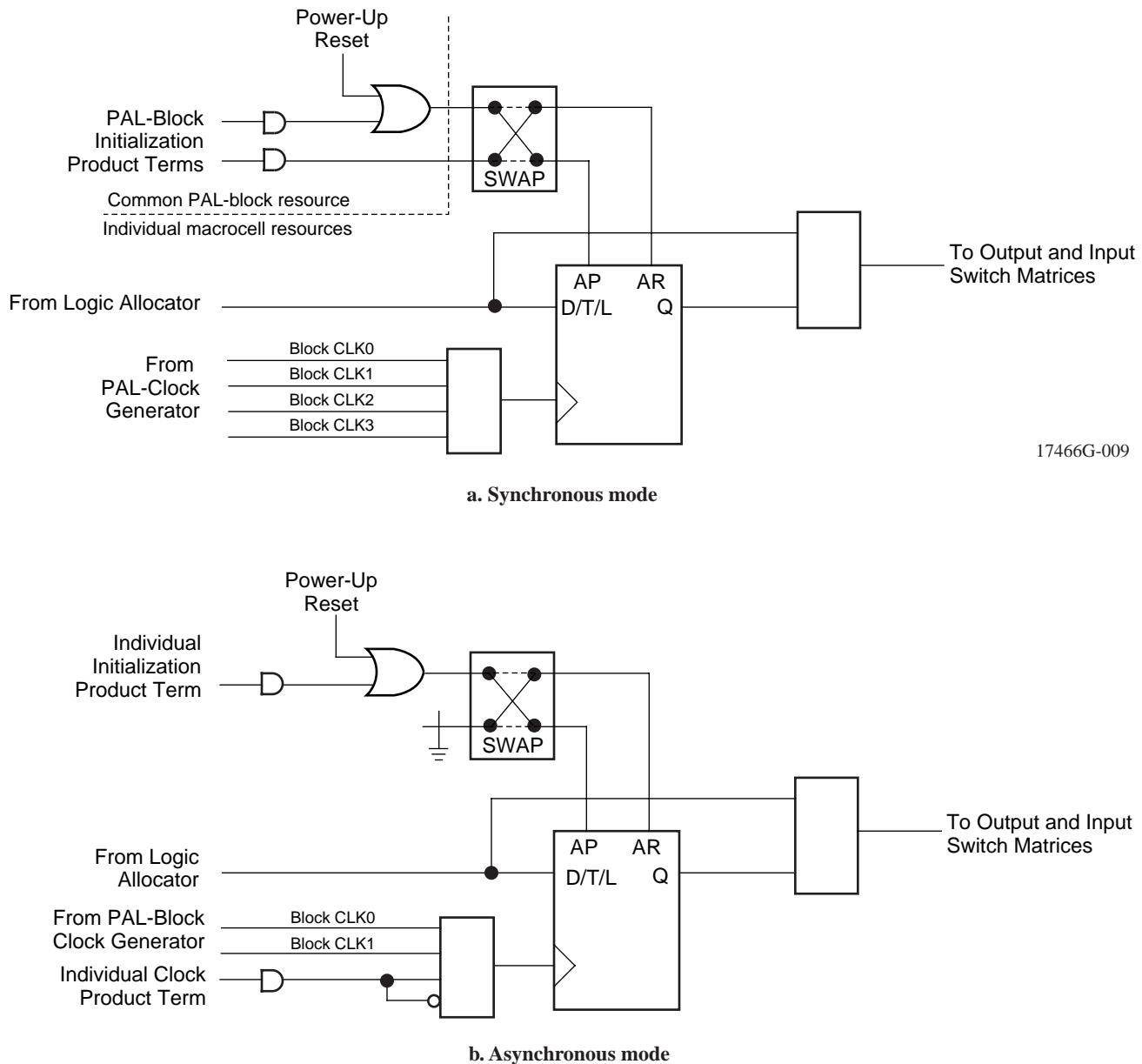


Figure 5. Macrocell

In either mode, a combinatorial path can be used. For combinatorial logic, the synchronous mode will generally be used, since it provides more product terms in the allocator.

**Table 10. Output Switch Matrix Combinations for ispMACH 4A Devices with 2:1 Macrocell-I/O Cell Ratio**

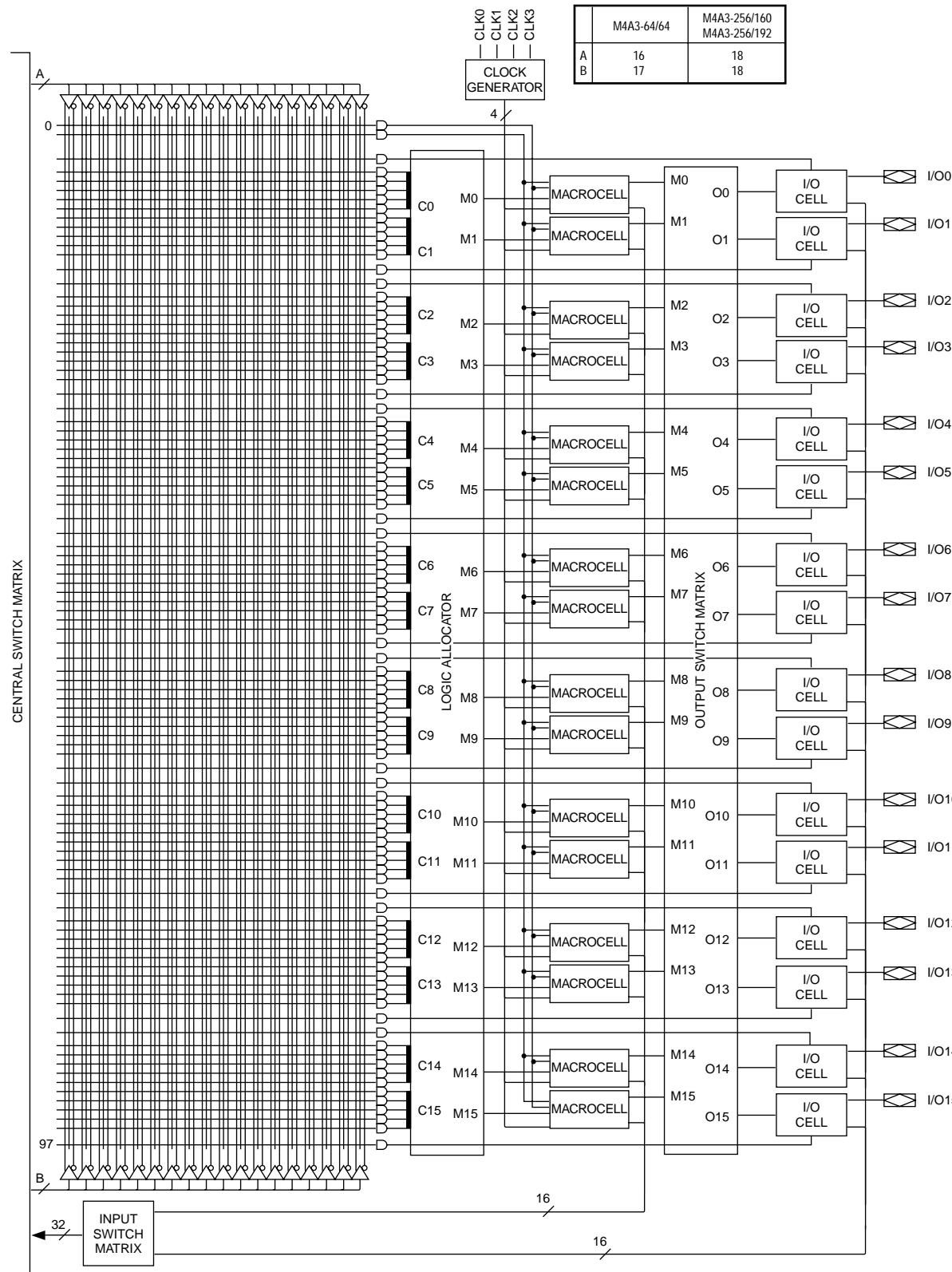
Macrocell	Routeable to I/O Cells
M12, M13	I/03, I/04, I/05, I/06
M14, M15	I/04, I/05, I/06, I/07

I/O Cell	Available Macrocells
I/00	M0, M1, M2, M3, M4, M5, M6, M7
I/01	M2, M3, M4, M5, M6, M7, M8, M9
I/02	M4, M5, M6, M7, M8, M9, M10, M11
I/03	M6, M7, M8, M9, M10, M11, M12, M13
I/04	M8, M9, M10, M11, M12, M13, M14, M15
I/05	M0, M1, M10, M11, M12, M13, M14, M15
I/06	M0, M1, M2, M3, M12, M13, M14, M15
I/07	M0, M1, M2, M3, M4, M5, M14, M15

**Table 11. Output Switch Matrix Combinations for M4A3-256/160 and M4A3-256/192**

Macrocell	Routeable to I/O Cells							
M0	I/00	I/01	I/02	I/03	I/04	I/05	I/06	I/07
M1	I/00	I/01	I/02	I/03	I/04	I/05	I/06	I/07
M2	I/00	I/01	I/02	I/03	I/04	I/05	I/06	I/07
M3	I/00	I/01	I/02	I/03	I/04	I/05	I/06	I/07
M4	I/00	I/01	I/02	I/03	I/04	I/05	I/06	I/07
M5	I/00	I/01	I/02	I/03	I/04	I/05	I/06	I/07
M6	I/00	I/01	I/02	I/03	I/04	I/05	I/06	I/07
M7	I/00	I/01	I/02	I/03	I/04	I/05	I/06	I/07
M8	I/08	I/09	I/010	I/011	I/012	I/013	I/014	I/015
M9	I/08	I/09	I/010	I/011	I/012	I/013	I/014	I/015
M10	I/08	I/09	I/010	I/011	I/012	I/013	I/014	I/015
M11	I/08	I/09	I/010	I/011	I/012	I/013	I/014	I/015
M12	I/08	I/09	I/010	I/011	I/012	I/013	I/014	I/015
M13	I/08	I/09	I/010	I/011	I/012	I/013	I/014	I/015
M14	I/08	I/09	I/010	I/011	I/012	I/013	I/014	I/015
M15	I/08	I/09	I/010	I/011	I/012	I/013	I/014	I/015

I/O Cell	Available Macrocells							
I/00	M0	M1	M2	M3	M4	M5	M6	M7
I/01	M0	M1	M2	M3	M4	M5	M6	M7
I/02	M0	M1	M2	M3	M4	M5	M6	M7
I/03	M0	M1	M2	M3	M4	M5	M6	M7
I/04	M0	M1	M2	M3	M4	M5	M6	M7
I/05	M0	M1	M2	M3	M4	M5	M6	M7
I/06	M0	M1	M2	M3	M4	M5	M6	M7
I/07	M0	M1	M2	M3	M4	M5	M6	M7



17466H-41

Figure 17. PAL Block for ispMACH 4A Devices with 1:1 Macrocell-I/O Cell Ratio (except M4A (3,5)-32/32)

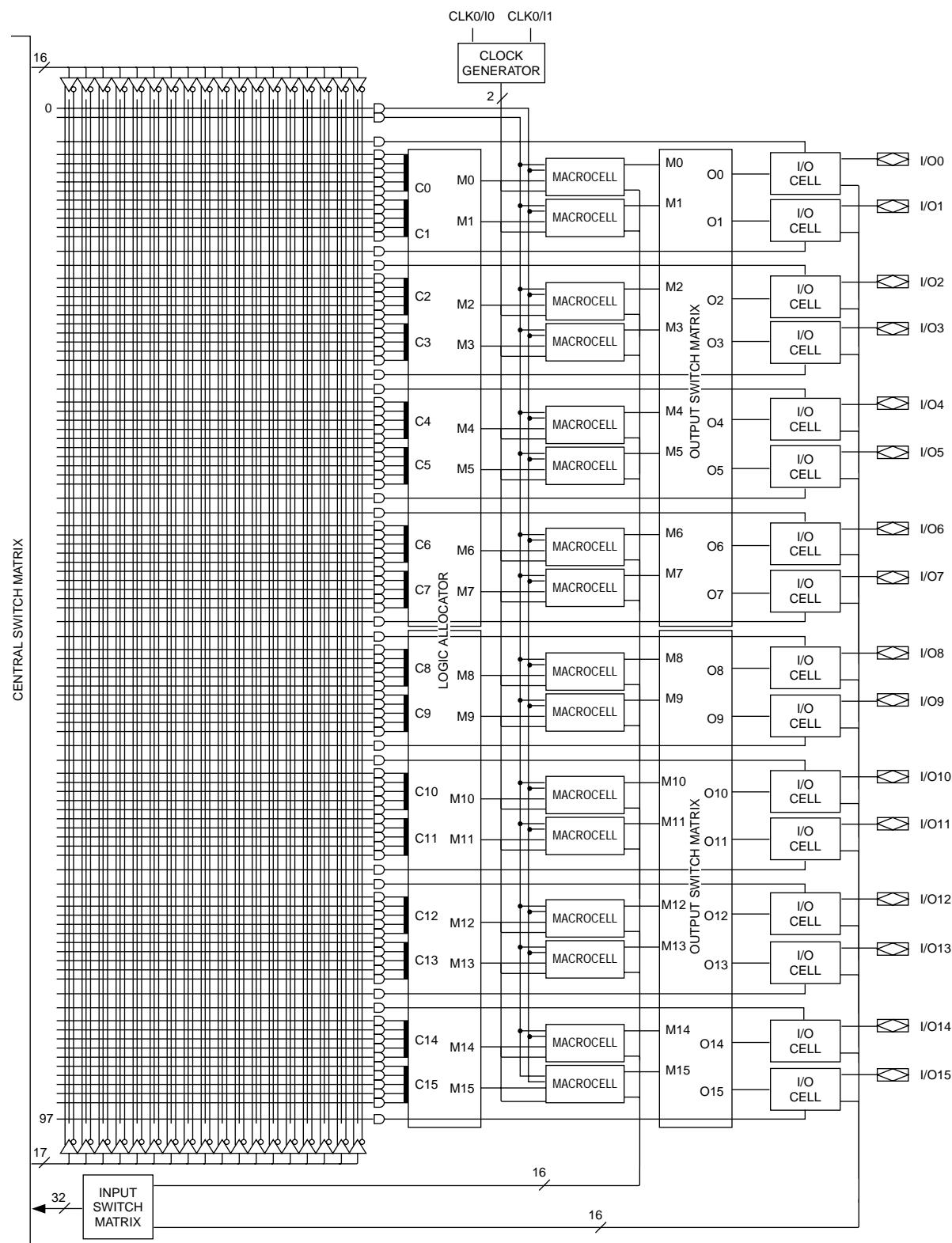
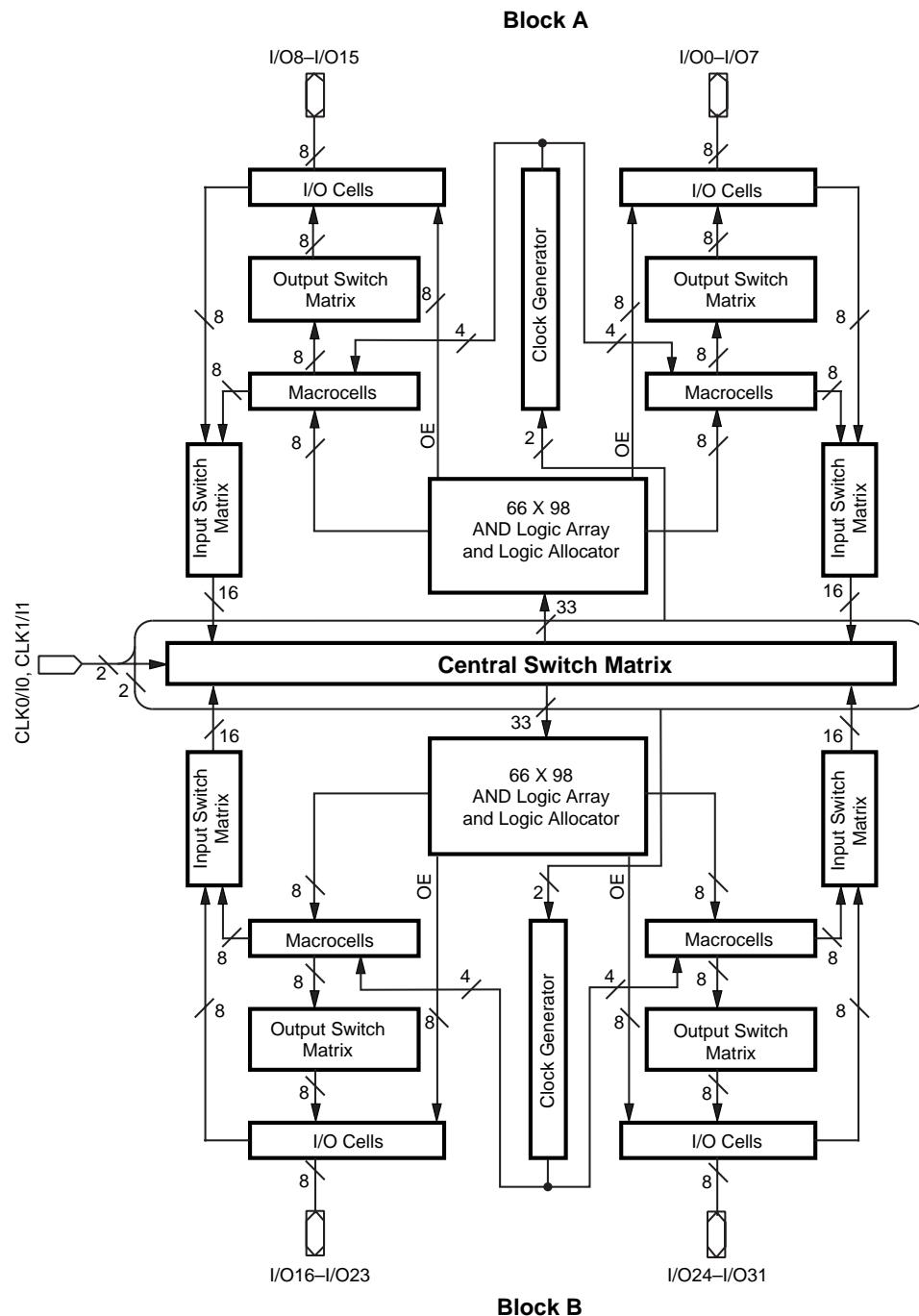


Figure 18. PAL Block for M4A (3,5)-32/32

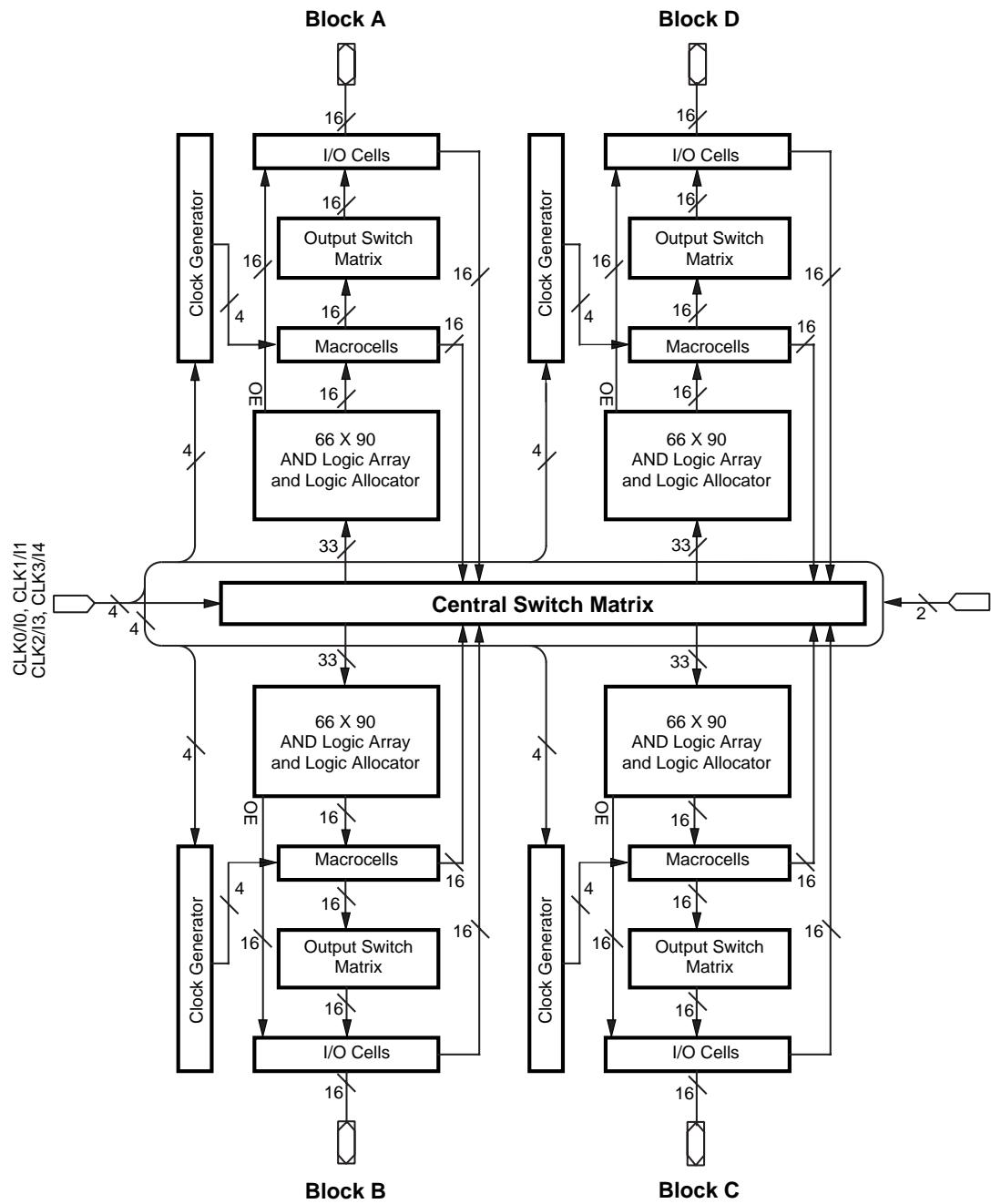
17466H-042

## BLOCK DIAGRAM – M4A(3,5)-32/32

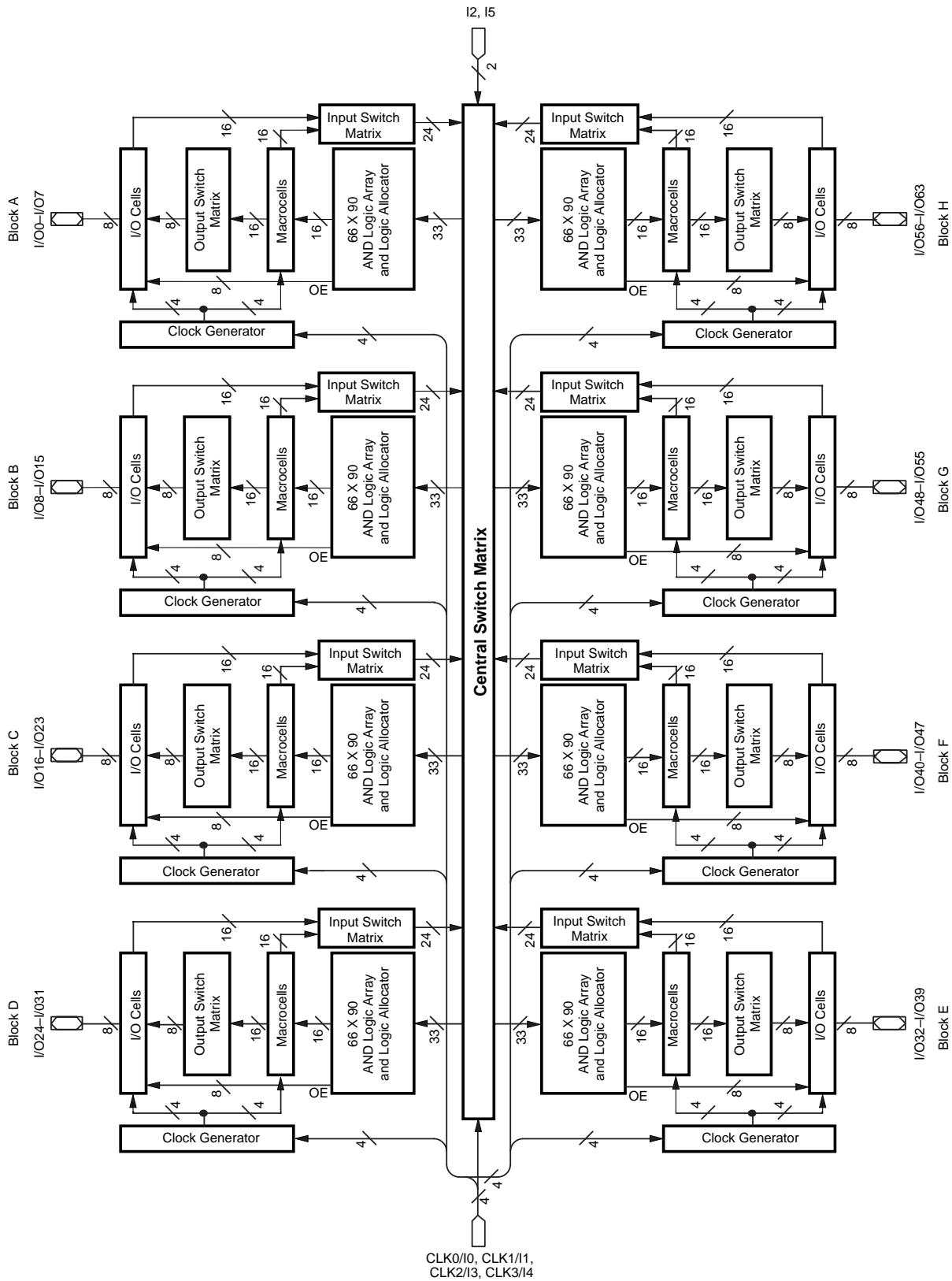


17466H-019

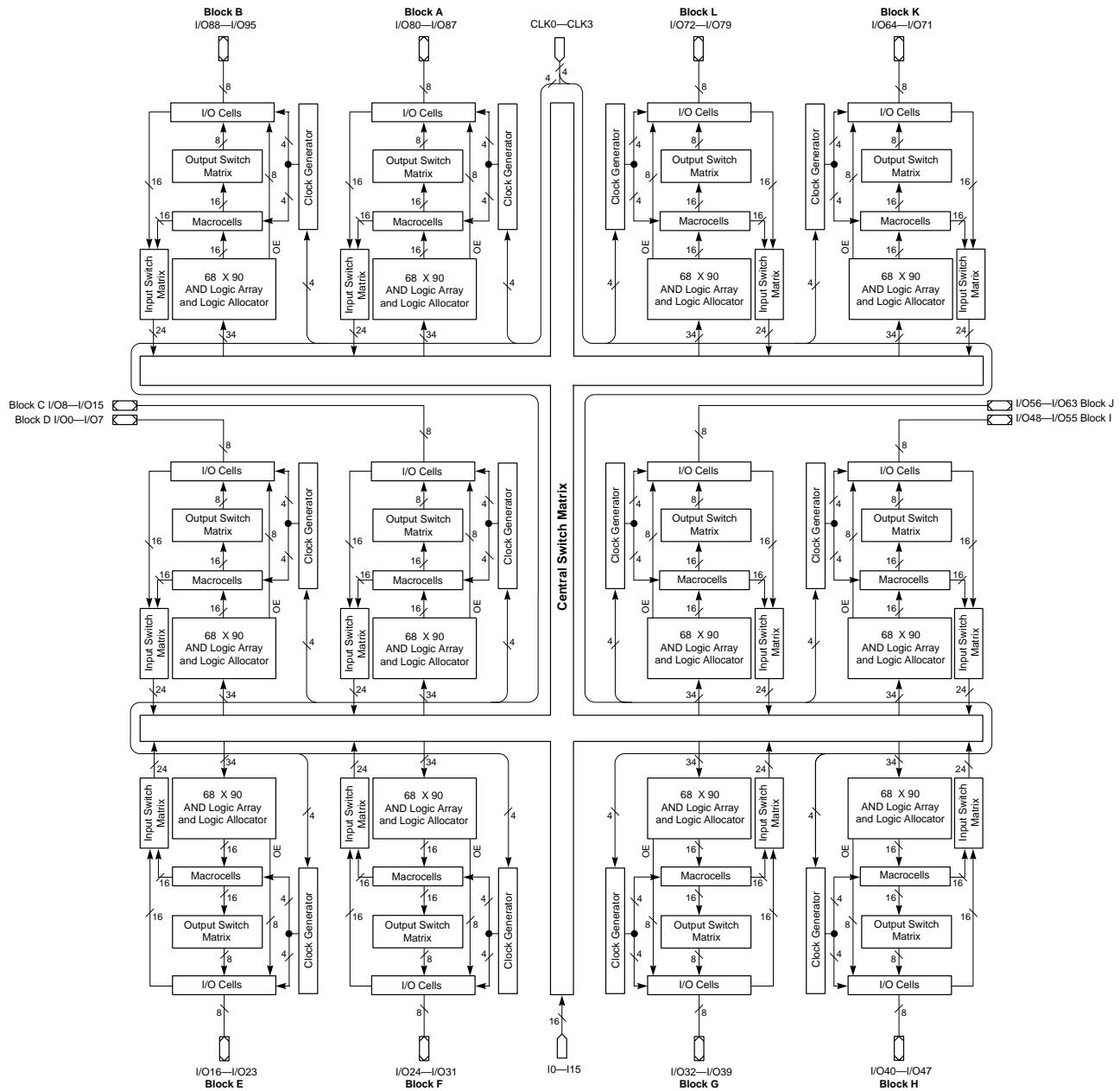
## BLOCK DIAGRAM – M4A3-64/64



## BLOCK DIAGRAM – M4A(3,5)-128/64

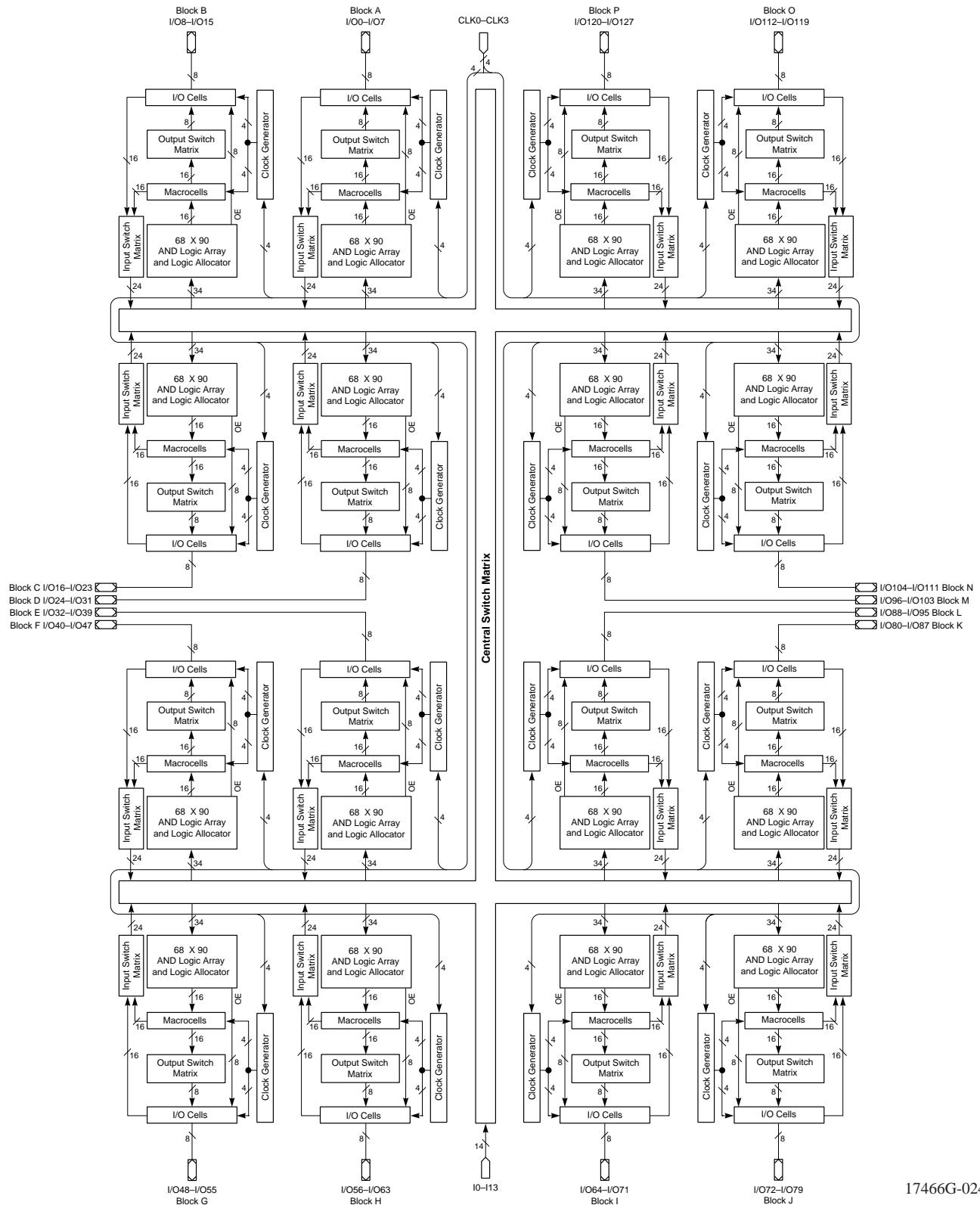


## BLOCK DIAGRAM – M4A(3,5)-192/96

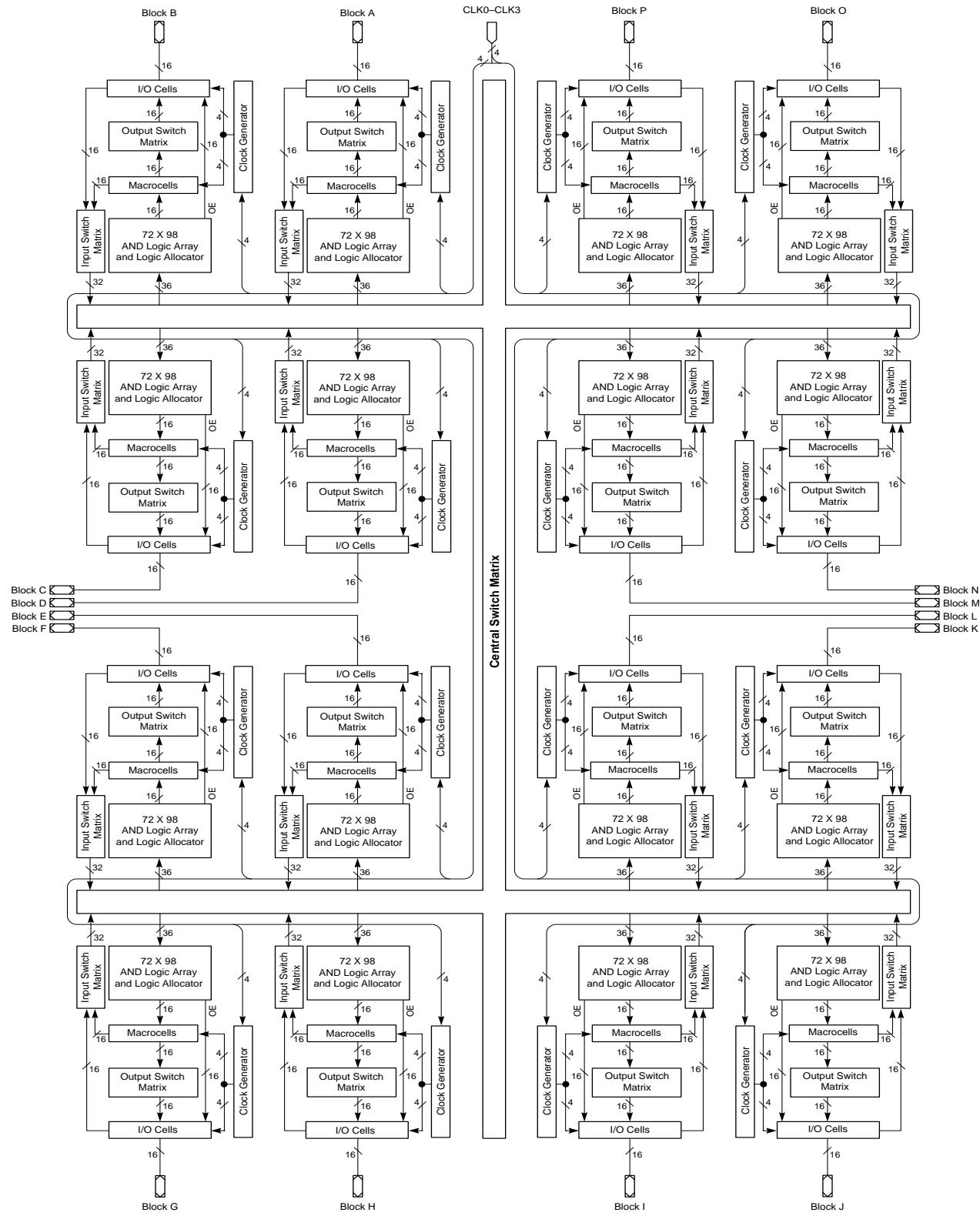


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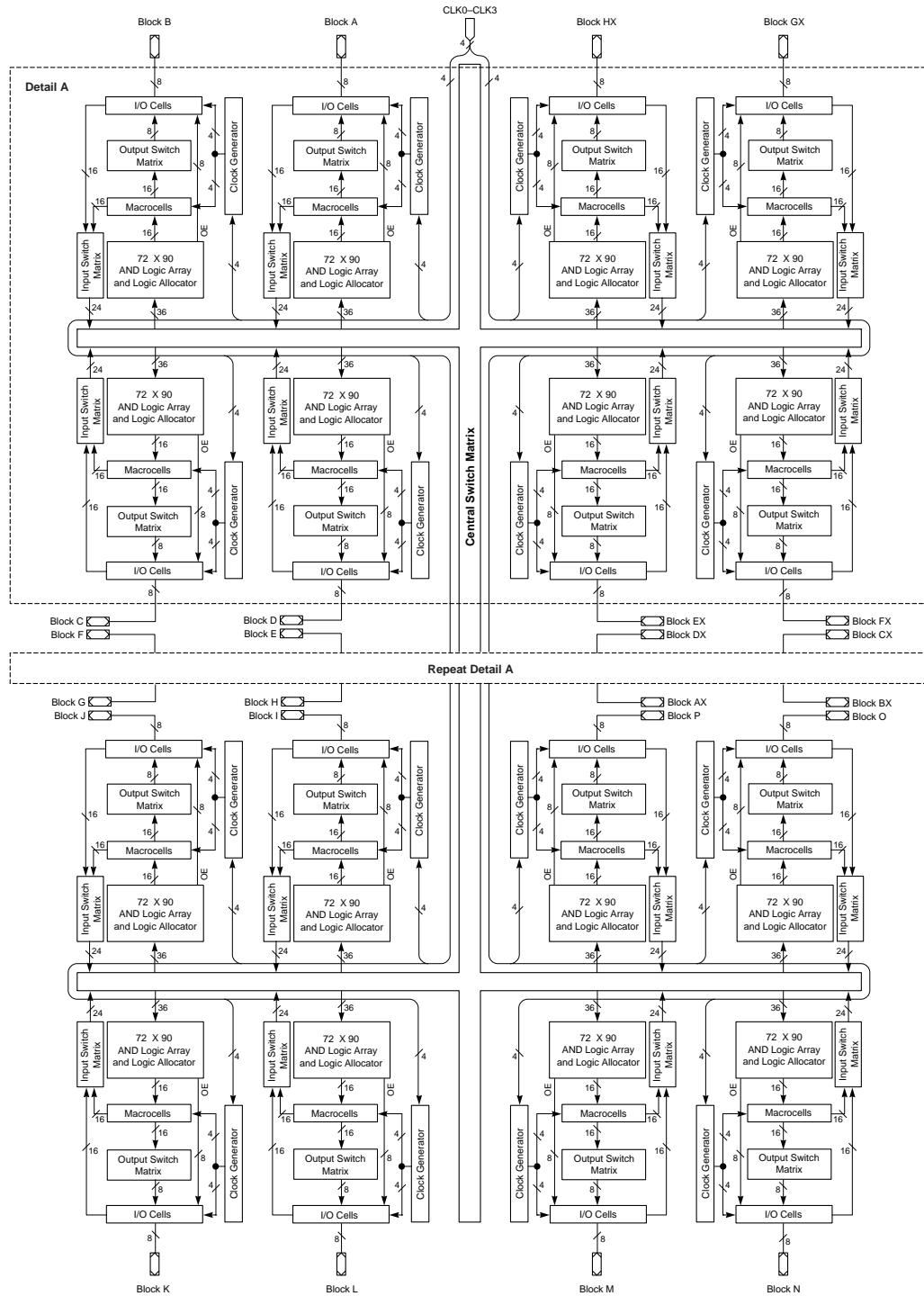
## BLOCK DIAGRAM – M4A(3,5)-256/128



## BLOCK DIAGRAM – M4A3-256/160, M4A3-256/192



## BLOCK DIAGRAM – M4A3-384/160, M4A3-384/192



## 144-BALL FPBGA CONNECTION DIAGRAM (M4A3-192/96)

### Bottom View

144-Ball fpBGA

	12	11	10	9	8	7	6	5	4	3	2	1	
A	GND	I/O72 L7	I/O76 L3	I13	GBCLK3	I0	I/O82 A2	I/O86 A6	I/O88 B0	I/O93 B5	I/O95 B7	GND	A
B	GND	I/O73 L6	I/O77 L2	I/O79 L0	VCC	I1	I/O83 A3	I/O87 A7	I/O90 B2	I/O94 B6	I/O0 D7	TDI	B
C	GND	TDO	I/O74 L5	I14	GND	I/O80 A0	I/O84 A4	GND	I/O92 B4	I/O1 D6	I/O4 D3	I/O3 D4	C
D	I/O67 K4	I/O69 K2	I/O71 K0	I/O75 L4	GBCLK0	I/O81 A1	VCC	I/O91 B3	I/O2 D5	I2	I/O6 D1	I/O7 D0	D
E	I12	I/O64 K7	I/O66 K5	I/O70 K1	I/O78 L1	I/O85 A5	I/O89 B1	I/O5 D2	I/O8 C7	I4	GND	VCC	E
F	I10	I11	GND	I/O65 K6	I/O68 K3	I15	I3	GND	I/O12 C3	I/O11 C4	I/O10 C5	I/O9 C6	F
G	I/O60 J3	I/O61 J2	I/O62 J1	I/O63 J0	VCC	GND	I7	I/O20 E3	I/O17 E6	I/O15 C0	I/O14 C1	I/O13 C2	G
H	I/O56 J7	I/O57 J6	I/O58 J5	I/O59 J4	I/O53 I2	I/O41 H1	I/O37 G5	I/O30 F1	I/O22 E1	I/O18 E5	I/O16 E7	VCC	H
J	I/O55 I0	I/O54 I1	VCC	I/O50 I5	I/O43 H3	VCC	I/O33 G1	GBCLK2	I/O27 F4	I/O23 E0	I/O21 E2	I/O19 E4	J
K	I/O51 I4	I/O52 I3	I/O49 I6	I/O44 H4	GND	I/O36 G4	I/O32 G0	VCC	I6	I/O26 F5	TCK	TMS	K
L	GND	I/O48 I7	I/O46 H6	I/O42 H2	I/O39 G7	I/O35 G3	I9	GND	I/O31 F0	I/O29 F2	I/O25 F6	GND	L
M	GND	I/O47 H7	I/O45 H5	I/O40 H0	I/O38 G6	I/O34 G2	I8	GBCLK1	I5	I/O28 F3	I/O24 F7	GND	M

### PIN DESIGNATIONS

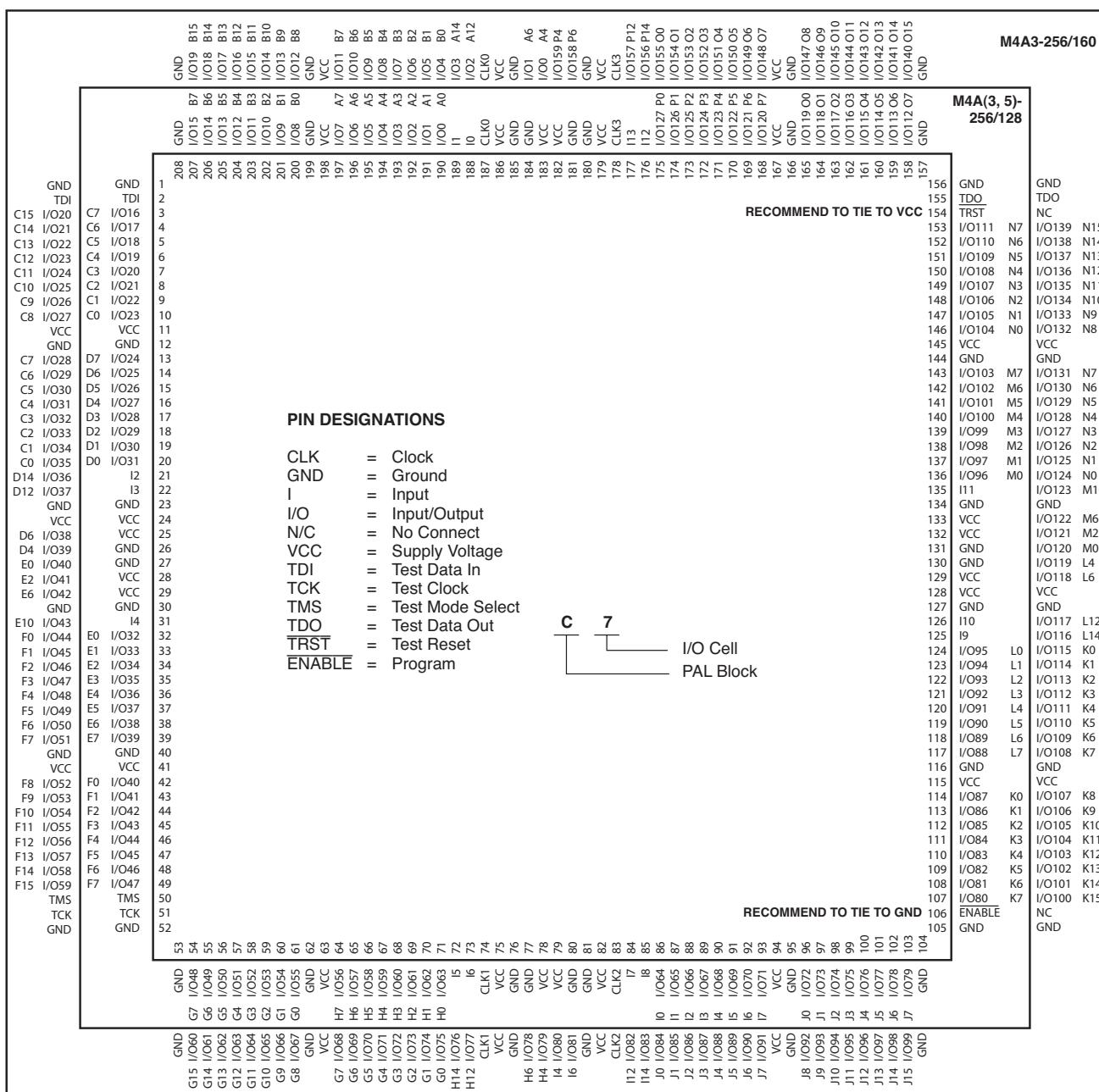
CLK	= Clock
GND	= Ground
I	= Input
I/O	= Input/Output
N/C	= No Connect
VCC	= Supply Voltage
TDI	= Test Data In
TCK	= Test Clock
TMS	= Test Mode Select
TDO	= Test Data Out



## **208-PIN PQFP CONNECTION DIAGRAM (M4A(3,5)-256/128 AND M4A3-256/160)**

## Top View

208-Pin PQFP



17466G-044

## 256-BALL fpBGA CONNECTION DIAGRAM (M4A3-256/192)

### Bottom View

256-Ball fpBGA

	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	
A	I/O167 N15	I/O181 O13	I/O180 O12	I/O177 O9	I/O174 O6	I/O172 O4	I/O191 P14	I/O186 P4	I/O1 A2	I/O3 A6	GCLK0	I/O9 B1	I/O13 B5	I/O15 B7	I/O18 B10	I/O20 B12 <th>A</th>	A
B	I/O165 N13	I/O166 N14	I/O182 O14	I/O179 O11	I/O175 O7	I/O173 O5	I/O168 O0	I/O187 P6	I/O0 A0	I/O5 A10	I/O7 A14	I/O10 B2	I/O16 B8	I/O19 B11	I/O21 B13	NC	B
C	I/O163 N11	I/O164 N12	NC	I/O183 O15	I/O178 O10	I/O170 O2	I/O171 O3	I/O189 P10	I/O184 P0	I/O6 A12	I/O12 B4	I/O14 B6	I/O23 B15	I/O22 B14	TDI	I/O39 C15	C
D	I/O158 N6	I/O159 N7	TDO	GND	GND	VCC	GND	VCC	GND	GND	VCC	GND	VCC	I/O17 B9	I/O38 C14	I/O37 C13	D
E	I/O156 N4	NC	I/O162 N10	VCC	I/O160 N8	I/O161 N9	I/O190 P12	GCLK3	I/O188 P8	I/O2 A4	I/O8 B0	NC	GND	I/O36 C12	I/O35 C11	I/O31 C7	E
F	I/O152 N0	I/O157 N5	I/O155 N3	GND	I/O154 N2	I/O153 N1	I/O176 O8	I/O169 O1	I/O185 P2	I/O4 A8	I/O11 B3	I/O34 C10	VCC	I/O32 C8	I/O30 C6	I/O29 C5	F
G	I/O147 M6	I/O150 M12	I/O149 M10	VCC	I/O148 M8	I/O151 M14	VCC	GND	GND	VCC	I/O33 C9	I/O28 C4	GND	I/O26 C2	I/O25 C1	I/O47 D14	G
H	I/O144 M0	I/O146 M4	I/O145 OM2	GND	I/O136 L0	I/O137 L2	GND	VCC	VCC	GND	I/O27 C3	I/O24 C0	VCC	I/O44 D8	I/O43 D6	I/O42 D4	H
J	I/O138 L4	I/O139 L6	I/O140 L8	GND	I/O142 L12	I/O141 L10	GND	VCC	VCC	GND	I/O46 D12	I/O45 D10	GND	I/O49 E2	I/O48 E0	I/O50 E4	J
K	I/O143 L14	I/O120 K0	I/O121 K1	VCC	I/O123 K3	I/O122 K2	VCC	GND	GND	VCC	I/O41 D2	I/O40 D0	VCC	I/O55 E14	I/O54 E12	I/O56 F0	K
L	I/O124 K4	I/O125 K5	I/O127 K7	GND	I/O130 K10	I/O126 K6	I/O98 I4	I/O91 H6	I/O75 G3	I/O77 G5	I/O52 E8	I/O51 E6	GND	I/O59 F3	I/O60 F4	I/O57 F1	L
M	I/O128 K8	I/O129 K9	I/O131 K11	GND	I/O107 J3	I/O105 J1	I/O100 I8	I/O90 H4	I/O74 G2	I/O80 G8	I/O83 G11	I/O53 E10	VCC	I/O68 F12	I/O63 F7	I/O58 F2	M
N	I/O132 K12	I/O133 K13	I/O135 K15	VCC	GND	VCC	GND	VCC	GND	VCC	GND	GND	TCK	I/O64 F8	I/O61 F5	N	
P	I/O134 K14	I/O117 J13	I/O118 J14	I/O119 J15	I/O108 J4	I/O106 J2	I/O101 I10	I/O89 H2	I/O93 H10	I/O94 H12	I/O79 G7	I/O84 G12	I/O87 G15	TMS	I/O65 F9	I/O62 F6	P
R	I/O116 J12	I/O115 J11	I/O112 J8	I/O111 J7	I/O104 J0	I/O102 I12	I/O99 I6	I/O96 I0	I/O92 H8	I/O72 G0	I/O76 G4	I/O81 G9	I/O85 G13	I/O71 F15	I/O67 F11	I/O66 F10	R
T	I/O114 J10	I/O113 J9	I/O110 J6	I/O109 J5	I/O103 I14	GCLK2	I/O97 I2	I/O88 H0	GCLK1	I/O95 H14	I/O73 G1	I/O78 G6	I/O82 G10	I/O86 G14	I/O70 F14	I/O69 F13	T

### PIN DESIGNATIONS

CLK = Clock  
 GND = Ground  
 I = Input  
 I/O = Input/Output  
 N/C = No Connect  
 VCC = Supply Voltage  
 TDI = Test Data In  
 TCK = Test Clock  
 TMS = Test Mode Select  
 TDO = Test Data Out



## ispMACH 4A PRODUCT ORDERING INFORMATION

### ispMACH 4A Devices Commercial and Industrial - 3.3V and 5V

Lattice programmable logic products are available with several ordering options. The order number (Valid Combination) is formed by a combination of:

M4A3-	256 / 128	-7	Y	C	T <sub>48</sub>	= 48-pin TQFP for M4A3-32/32 or M4A3-64/32 M4A5-32/32 or M4A5-64/32
<b>FAMILY TYPE</b>						
M4A3- = ispMACH 4A Family Low Voltage Advanced Feature (3.3-V V <sub>CC</sub> )						
M4A5- = ispMACH 4A Family Advanced Feature (5-V V <sub>CC</sub> )						
<b>MACROCELL DENSITY</b>						
32	= 32 Macrocells	192	= 192 Macrocells			
64	= 64 Macrocells	256	= 256 Macrocells			
96	= 96 Macrocells	384	= 384 Macrocells			
128	= 128 Macrocells	512	= 512 Macrocells			
<b>I/Os</b>						
/32	= 32 I/Os in 44-pin PLCC, 44-pin TQFP or 48-pin TQFP					
/48	= 48 I/Os in 100-pin TQFP					
/64	= 64 I/Os in 100-pin TQFP, 100-pin PQFP, or 100-ball caBGA					
/96	= 96 I/Os in 144-pin TQFP or 144-ball fpBGA					
/128	= 128 I/Os in 208-pin PQFP, 256-ball BGA or 256-ball fpBGA					
/160	= 160 I/Os in 208-pin PQFP					
/192	= 192 I/Os in 256-ball BGA or 256-ball fpBGA					
/256	= 256 I/Os in 388-ball fpBGA					
<b>OPERATING CONDITIONS</b>						
C = Commercial (0°C to +70°C)						
I = Industrial (-40°C to +85°C)						
<b>PACKAGE TYPE</b>						
SA = Ball Grid Array (BGA)						
J = Plastic Leaded Chip Carrier (PLCC)						
JN = Lead-free Plastic Leaded Chip Carrier (PLCC)						
V = Thin Quad Flat Pack (TQFP)						
VN = Lead-free Thin Quad Flat Pack (TQFP)						
Y = Plastic Quad Flat Pack (PQFP)						
YN = Lead-free Plastic Quad Flat Pack (PQFP)						
FA = Fine-pitch Ball Grid Array (fpBGA)						
FAN = Lead-free Fine-pitch Ball Grid Array (fpBGA)						
CA = Chip-array Ball Grid Array (caBGA)						
<b>SPEED</b>						
-5 = 5.0 ns t <sub>PD</sub>						
-55 = 5.5 ns t <sub>PD</sub>						
-6 = 6.0 ns t <sub>PD</sub>						
-65 = 6.5 ns t <sub>PD</sub>						
-7 = 7.5 ns t <sub>PD</sub>						
-10 = 10 ns t <sub>PD</sub>						
-12 = 12 ns t <sub>PD</sub>						
-14 = 14 ns t <sub>PD</sub>						

\*Package obsolete, contact factory.

### Conventional Packaging

3.3V Commercial Combinations		
M4A3-32/32	-5, -7, -10	JC, VC, VC48
M4A3-64/32		JC, VC, VC48
M4A3-64/64		VC
M4A3-96/48		VC
M4A3-128/64		YC, VC, CAC
M4A3-192/96	-6, -7, -10	VC, FAC
M4A3-256/128	-55, -65 <sup>1</sup> , -7, -10	YC, FAC, SAC
M4A3-256/160		YC
M4A3-256/192	-7, -10	FAC
M4A3-384/160		YC
M4A3-384/192	-65, -10, -12	SAC, FAC
M4A3-512/160		YC
M4A3-512/192		FAC
M4A3-512/256	-7, -10, -12	FAC

3.3V Industrial Combinations		
M4A3-32/32		JI, VI, VI48
M4A3-64/32		JI, VI, VI48
M4A3-64/64		VI
M4A3-96/48		VI
M4A3-128/64		YI, VI, CAI
M4A3-192/96		VI, FAI
M4A3-256/128		YI, FAI, SAI
M4A3-256/160		YI
M4A3-256/192	-10, -12	FAI
M4A3-384/160		YI
M4A3-384/192		FAI
M4A3-512/160		YI
M4A3-512/192		FAI
M4A3-512/256	-10, -12, -14	FAI

1. Use 5.5ns for new designs.

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## Revision History

Date	Version	Change Summary
-	K	Previous Lattice release.
August 2006	L	Updated for lead-free package options.
September 2006	M	Revised M4A3-256/160 208-pin PQFP connection diagram.